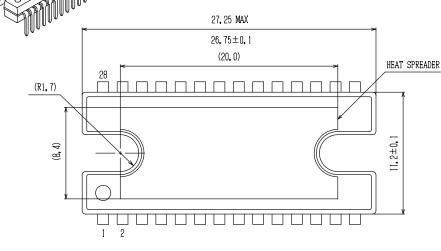
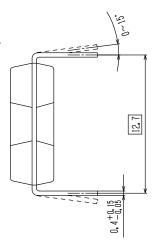
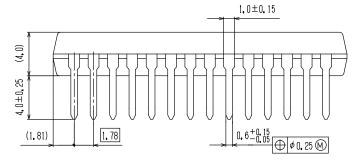
## PDIP28 W/ HEAT SPREADER / DIP28H (500 mil) CASE 646AX

CASE 646AX ISSUE A

**DATE 16 OCT 2013** 







## GENERIC MARKING DIAGRAM\*



XXXXX = Specific Device Code

Y = Year

M = Month

DDD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

## (Unit: mm)

Reference	Package name
symbol	DIP28H (500 mil)
e1	12.70
е	1.78
-	

Through Hole Area

NOTE: The measurements are not to guarantee but for reference only.

е

**SOLDERING FOOTPRINT\*** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	PDIP28 26.75X11.2MM, 1.78P W/ HEAT	PAGE 1 OF 2	

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PAGE 2 OF 2

ISSUE	REVISION	DATE				
0	RELEASED FOR PRODUCTION FROM SANYO ENACT# S-146 TO ON SEMICONDUCTOR. REQ. BY D. TRUHITTE.	30 NOV 2011				
А	ADDED MARKING AND SOLDER FOOTPRINT INFORMATION. REQ. BY D. TRUHITTE.	16 OCT 2013				

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